

(19) World Intellectual Property
Organization
International Bureau



(43) International Publication Date
27 January 2005 (27.01.2005)

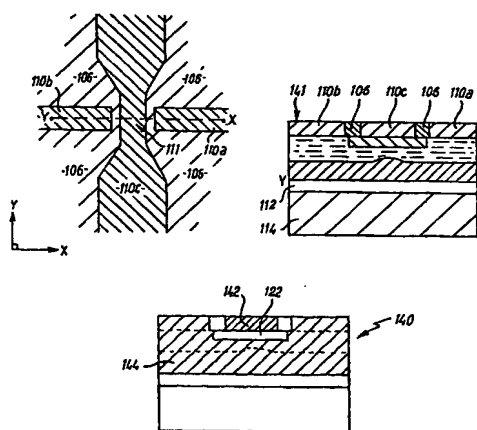
PCT

(10) International Publication Number
WO 2005/009095 A1

- (51) International Patent Classification⁷: **H05K 3/20**, 3/46, H01L 23/538
- (21) International Application Number: PCT/GB2004/002983
- (22) International Filing Date: 9 July 2004 (09.07.2004)
- (25) Filing Language: English
- (26) Publication Language: English
- (30) Priority Data: 0316351.6 12 July 2003 (12.07.2003) GB
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- (81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.
- (84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).
- Published:
— with international search report

[Continued on next page]

(54) Title: A CROSS-OVER OF CONDUCTIVE INTERCONNECTS AND A METHOD OF CROSSING CONDUCTIVE INTERCONNECTS



(57) Abstract: A cross-over (140) of first (142) and second (144) separate elongate conductive interconnects, comprising: a first elongate conductive interconnect (142); a first conductive portion (110a) separate from the first elongate conductive interconnect (142); a second conductive portion (110b) separate from the first elongate conductive interconnect (142); first insulating material (122) adjacent at least a portion (111) of the first elongate conductive interconnect (142); and a third electro-deposited metal portion (124) extending adjacent the first insulating material (122) to interconnect the first (110a) and second (110b) conductive portions, wherein the first (110a), second (110b) and third (124) portions are interconnected portions of the second elongate conductive interconnect (144); and a substrate, wherein the first insulating material and the third electro-deposited metal portion are positioned between the substrate and the first elongate conductive interconnect.



For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.